### 505259516 01/02/2019

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
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HUAN GE	12/14/2018
CHENGXIA JI	12/15/2018

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#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16233370

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ATTORNEY DOCKET NUMBER:	1091-2018A1488US
NAME OF SUBMITTER:	NA XU
SIGNATURE:	/Na Xu/
DATE SIGNED:	01/02/2019

#### **Total Attachments: 4**

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> PATENT REEL: 048001 FRAME: 0428

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Attorney Docket No.: 1091-2018A1488US

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## ASSIGNMENT

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:
Electronic device
for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on(Application No); and

WHEREAS. AAC Technologies Pte. Ltd., a corporation of Singapore whose post office address is 85 Science Park Drive #02-08. The Cavendish, Singapore 118259 (hereinafter referred to as Assignee) is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, IWE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and teatify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful daths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HE	EREBY authorize and r	equest the attorneys I/	we have empowered	d in the
Declaration and Powe	r of Attorney in this app	olication, to insert here	in parentheses (App	lication No.
filed	) the filing date and a	application number of	said application whe	n known.

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PATENT REEL: 048001 FRAME: 0429 PATENT

Attorney Docket No.: 1091-2018A1488US

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IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Inventor:

Name:

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Signature:

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PATENT REEL: 048001 FRAME: 0431

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**RECORDED: 01/02/2019** 

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PATENT REEL: 048001 FRAME: 0432

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